PHONON SCATTERING DUE TO DEEP ACCEPTORS IN SEMICONDUCTORS

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We have measured the magnetothermal conductivity in GaAs(Mn) [3.8x10¹⁸ cm⁻³] and Si(In) [5x10⁵ cm⁻³] for temperatures between 1.4 K and 90 K at magnetic fields up to 8 T. In both cases the dopants are deep acceptors with binding energy much larger (110 meV and 165 meV). There is a double interest in such systems: First, an excited level 3 meV ($l_{*.2}$ meV) above the acceptor ground state has been concluded from ultrasonic measurements /1/ /2/. Such an excited state might be connected with a Jahn-Teller effect of these deeper accepductivity. Second, an anomalous behavior of the magnetothermal conductivity. Second, an anomalous behavior of the magnetothermal conductivity has been found for shallow acceptors in G (but not in Si) /3/ making comparison with systems with different g-factors desirable. The g-factors of acceptors in GaAs are roughly three times, the g-factor of Si(In) about 0.6 times that of Si[B).

In zero magnetic field in both cases we see a strong reduction of the thermal conductivity at low temperatures as compared to the pure material scaling well in concentration with the reduction found for shallow acceptors; furthermore, a distinct dip is seen at about 23 K for Si[In] (Fig. 1) and at about 12 K for GaAs[Mn] (Fig. 2). The same dip has been found for GaAs(Mn) by Holland /4/ at concentrations lower than ours. The maximum thermal conductivity for Si[In] is reduced due to about 10¹⁰ cm³ oxygen contained in the sample /2/15/. The dependence on magnetic field is analogous to that found by Challis and Halbo /3/ for Si[B]: The relative thermal conductivity c_{0}/z_{c} for GaAs(Mn) first falls to a minimum value of about 0.6 (due to an enlarged resonant scattering) and then rises rapidly (Fig. 3). However, this rise tends to saturat at the highest fields to a value about ten times below that of the pure crystal, which may be due to



Fig.1 Thermal conductivity in Si(In).



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the low frequency part of the resonance scattering associated with the dip at 12 K. As is expected from the small g-factor, the variation of α_B/α_c for Si(In) is slow; that is, only a reduction is seen attaining a minimum value of 0.8 at 2 K and 8 T. Thus, in both cases the magnetic field dependence does not show the "anomaly" found for shallow acceptors in Ge. However, the variation of α_B/α_c for Si(In) seems to be somewhat slower than can be accounted for by the g-factor and, in the case of GaAs(Mn), the minima of α_B/α_c at different temperatures do not scale very well with B/T, but there is a part $\propto < (B/T)^2$.

For an analysis of x, we applied a modified model for the acceptor ground state: A distribution of small splittings & (determining the low temperature part of the scattering) and an excited level Δ above these split levels. The extended nature of the acceptor wave function, reducing the interaction with short wavelength phonons, was taken into account (Bohr-radius 10 R for GaAs(Mn) and 7.4 Å for Si(In)). The formula for resonance fluorescence scattering in the form given by Suzuki and Mikoshiba /6/ was applied. The assumption $\delta \ll$ kT made for ease of calculation underestimates the scattering at the lowest temperatures. A good fit following the acute variation of Xo in the dip region especially for GaAs(Mn) was not possible. In both cases it was necessary to take a smaller Bohr radius for the excited level (3 Å for GaAs(Mn)). The best values for \mathbf{x}_0 thus obtained are 5 meV for Si(In) and 3 meV for GaAs(Mn). This has to be compared with the values analyzed from ultrasonic measurements. A more direct determination of these energies with quasimonochromatic phonons /7/ is desirable.

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